

BV <sub>DSX</sub> / BV <sub>DGX</sub>	R <sub>DS(ON)</sub> (max)	I <sub>DSS</sub> (min)	Package
250V	10Ω	220mA	SOT-89

#### **Features**

- Depletion mode device offers low R<sub>DS(ON)</sub> at cold temperatures
- Low on resistance 10 ohms max. at 25°C
- · High input impedance
- High breakdown voltage 250V
- Low V<sub>GS(off)</sub> voltage -1.6 to -3.9V
- Small package size SOT-89

### **Applications**

- Ignition modules
- Normally-on switches
- · Solid state relays
- Converters
- Telecommunications
- · Power supply

# Description

The CPC3710C is an N-channel depletion mode field effect transistor (FET) that utilizes Clare's proprietary third generation vertical DMOS process. Third generation process realizes world class, high voltage MOSFET performance in an economical silicon gate process. Our vertical DMOS process yields a robust device for high power applications with high input impedance. The CPC3710C is a highly reliable FET device that has been used extensively in Clare's solid state relays for industrial and telecommunications applications.

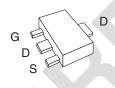
This device excels in power applications requiring low drain-source resistance, particularly in cold environments such as automotive ignition modules. The CPC3710C offers a low 10 ohm maximum onstate resistance at 25°C.

The CPC3710C has a minimum breakdown voltage of 250V and is available in an SOT-89 package. As with all MOS devices, the FET structure prevents thermal runaway and thermal-induced secondary breakdown.

## **Ordering Information**

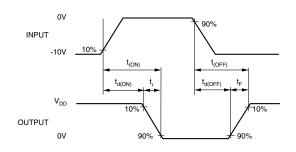
Part #	Description
CPC3710C	SOT-89 (100/Tube)
CPC3710CTR	SOT-89 (2000/Reel)

## **Package Pinout**

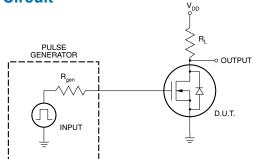


(SOT-89)

# **Switching Waveform**



#### **Test Circuit**





# **Absolute Maximum Ratings (@ 25° C)**

Parameter	Ratings	Units
Drain-to-Source Voltage	250	V
Gate-to-Source Voltage	±20	V
Total Package Dissipation	1.6 <sup>1</sup>	W
Operational Temperature	-55 to +125	°C
Storage Temperature	-55 to +125	°C

<sup>1</sup> Mounted on FR4 board 1"x1"x0.062"

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

## **Electrical Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Drain-to-Source Breakdown Voltage	BV <sub>DSX</sub>	$V_{GS} = -5V, I_{D} = 100 \mu A$	250	-	-	V
Gate-to-Source Off Voltage	V <sub>GS(off)</sub>	$V_{DS}$ = 10V, $I_{D}$ =1mA	-1.6	-2.5	-3.9	V
Change in V <sub>GS(off)</sub> with Temperatures	d <sub>VGS(off)</sub> /dT	V <sub>DS</sub> = 10V, I <sub>D</sub> =1mA	-	-	3.3	mV/°C
Gate Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm20V, V_{DS}=0V$	-	-	100	nA
Drain-to-Source Leakage Current		V <sub>GS</sub> = -5V, V <sub>DS</sub> =Max Rating	-	-	1	μA
Drain-to-Source Leakage Gurrent	<sup>I</sup> D(off)	$V_{GS}$ = -5V, $V_{DS}$ =0.8 Max Rating $T_A$ =125°C	-	-	1	mA
Saturated Drain-to-Source Current	I <sub>DSS</sub>	$V_{GS} = 0V, V_{DS} = 15V$	220	-	-	mA
Static Drain-to-Source ON-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =220mA	-	-	10	Ω
Change in RDS(on) with Temperatures	dR <sub>DS(on)</sub> /dT	V <sub>GS</sub> = 0V, I <sub>D</sub> =220mA	-	-	0.86	%/°C
Forward Transconductance	G <sub>FS</sub>	$I_{D} = 100 \text{mA}, V_{DS} = 10 \text{V}$	225	-	-	mΩ
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = -5V		100	350	
Common Source Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25V	-	30	80	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	f= 1Mhz		15	40	
Turn-ON Delay Time	t <sub>d(on)</sub>	V <sub>pp</sub> = 25V		23	35	
Rise Time	t <sub>r</sub>	I <sub>n</sub> = 150mA		8	20	ne
Turn-OFF Delay Time	t <sub>d(off)</sub>	$V_{GS} = 0V \text{ to } -10V$	-	17	25	ns
Fall time	t <sub>f</sub>	$R_{GEN} = 50\Omega$		70	80	
Source-Drain Diode Voltage Drop	$V_{SD}$	V <sub>GS</sub> = -5V, I <sub>SD</sub> = 150mA	-	0.6	1.8	V

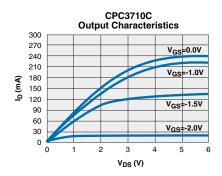
## **Thermal Characteristics**

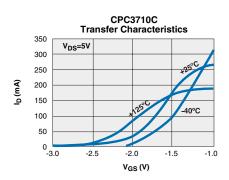
Package	I <sub>D</sub> (continuous)	I <sub>D</sub> (pulsed)	Power Dissipation @TA=25°C	θ <sub>ic</sub> °C/W	I <sub>DR</sub>	I <sub>DRM</sub>
S0T-89	220mA	600mA	1.6W <sup>1</sup>	15	220mA	600mA

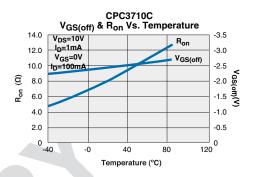
<sup>1</sup> Mounted on FR4 board 1"x1"x0.062"

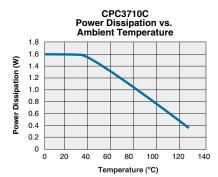


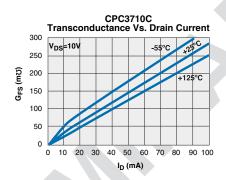
## **PERFORMANCE DATA\***

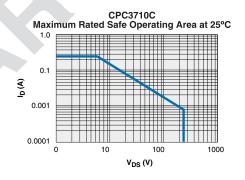


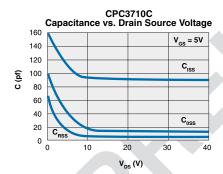


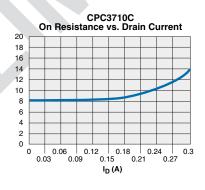












<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



## **Manufacturing Information**

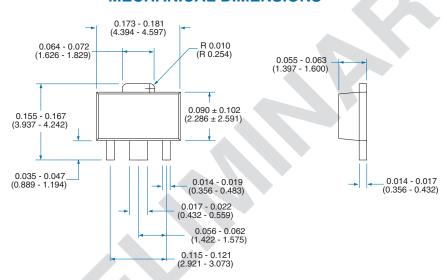
#### Soldering

Recommended soldering processes are limited to 220°C component body temperature for 10 seconds.

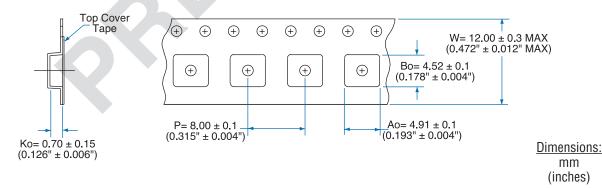
#### Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

### **MECHANICAL DIMENSIONS**



#### **Tape and Reel Information**



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